

TES imaging array technology for C_ℓOVER

Michael D. Audley, Robert W. Barker, Michael Crane, Roger Dace, Dorota Glowacka, David J. Goldie, Anthony N. Lasenby, Howard M. Stevenson, Vassilka Tsaneva, Stafford Withington^a, Paul Grimes, Bradley Johnson, Ghassan Yassin^b, Lucio Piccirillo, Giampaolo Pisano^c, William D. Duncan, Gene C. Hilton, Kent D. Irwin, Carl D. Reintsema^d, Mark Halpern^e

^aCavendish Laboratory, University of Cambridge, JJ Thomson Avenue, Cambridge, CB3 0HE, UK;

^bDepartment of Physics, University of Oxford, Denys Wilkinson Building, Keble Road, Oxford, OX1 3RH, UK;

^cSchool of Physics and Astronomy, Cardiff University, 5, The Parade, Cardiff, CF24 3YB, Wales, UK.;

^dNational Institute of Standards and Technology, 325 Broadway, Boulder, CO 80305, USA;

^e University of British Columbia, Department of Physics and Astronomy, 6224 Agricultural Rd., Vancouver, B.C., V6T 1Z1, Canada

ABSTRACT

C_ℓOVER is an experiment which aims to detect the signature of gravitational waves from inflation by measuring the B-mode polarization of the cosmic microwave background. C_ℓOVER consists of three telescopes operating at 97, 150, and 220 GHz. The 97-GHz telescope has 160 horns in its focal plane while the 150 and 220-GHz telescopes have 256 horns each. The horns are arranged in a hexagonal array and feed a polarimeter which uses finline-coupled TES bolometers as detectors. To detect the two polarizations the 97-GHz telescope has 320 detectors while the 150 and 220-GHz telescopes have 512 detectors each. To achieve the required NEPs the detectors are cooled to 100 mK for the 97 and 150-GHz polarimeters and 230 mK for the 220-GHz polarimeter. Each detector is fabricated as a single chip to guarantee fully functioning focal planes. The detectors are contained in linear modules made of copper which form split-block waveguides. The detector modules contain 16 or 20 detectors each for compatibility with the hexagonal arrays of horns in the telescopes' focal planes. Each detector module contains a time-division SQUID multiplexer to read out the detectors. Further amplification of the multiplexed signals is provided by SQUID series arrays. The first prototype detectors for C_ℓOVER operate with a bath temperature of 230 mK and are used to validate the detector design as well as the polarimeter technology. We describe the design of the C_ℓOVER detectors, detector blocks, and readout, and give an update on the detector development.*

Keywords: Microstrip-coupled bolometer, transition edge sensor, finline transition, time-domain SQUID multiplexer, CMB polarization, CLOVER

1. INTRODUCTION

1.1. Scientific motivation

Thomson scattering of primaeval radiation in the early Universe can lead to linear polarization¹ in the cosmic microwave background (CMB). The polarization depends on density fluctuations, and thus carries cosmological

Further author information: (Send correspondence to M.D.A.)

M.D.A.: E-mail: audley@mrao.cam.ac.uk, Telephone: +44(0)1223 337 309

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information which is complimentary to the well-studied temperature anisotropies of the CMB. The linear polarization may be decomposed into a curl-free part and a divergence-free part, denoted E- and B-mode respectively, by analogy with the electric field strength E and magnetic induction B . Linear density perturbations do not produce B-mode polarization, while tensor perturbations, as might be produced by gravitational waves, produce E- and B-mode polarization with similar amplitude.^{2,3} Thus, by measuring the B-mode polarization of the CMB with C_ℓ OVER we hope to make an indirect detection of a background of primordial gravitational waves.

1.2. Overview of C_ℓ OVER

The C_ℓ OVER experiment is described in detail elsewhere in these proceedings.⁴ C_ℓ OVER consists of three telescopes observing at frequencies of 97, 150, and 220 GHz. The focal plane of each telescope will be populated by feed horns, each connected to a polarimeter. The polarimeter technology is yet to be determined. As part of the technology development program for C_ℓ OVER we are constructing a Single Pixel Demonstrator. This instrument will contain six TES detectors, allowing us to evaluate different polarization technologies, as well as validating the detector design.

2. C_ℓ OVER DETECTORS

2.1. Detector Requirements

For maximum sensitivity, we require that the detectors be background-limited, i.e. the contributions to the noise equivalent power (NEP) from the detectors and readout must be less than half of the photon noise from the sky:

$$NEP_{det}^2 + NEP_{ro}^2 \leq \frac{1}{4} NEP_{photon}^2 \quad (1)$$

Once the detectors are background-limited the only way to improve the sensitivity is to increase the number of detectors. C_ℓ OVER's sensitivity requirements mean that we need 160 horns at 97 GHz and 256 each at 150 and 220 GHz. Because the polarimeter splits the power from each horn into two modes which must be measured independently, the number of detectors is twice this. We require a detector time constant of less than 1 ms. Also, the detectors must be able to absorb the power incident from the sky without saturation. This power is variable and depends on the weather. The power-handling requirement is for the detectors to be able to operate for 75% of the time at the site. The detector requirements are summarized in Table 1.

Table 1. C_ℓ OVER detector requirements at the three operating frequencies.

Centre Frequency (GHz)	Band (GHz)	Number of detectors	NEP Requirement (10^{-17} W/ $\sqrt{\text{Hz}}$)	Power Handling (pW)
97	82–112	320	1.5	6.7
150	127.5–172.5	512	2.5	11.5
220	195–255	512	4.5	18.8

2.2. Detector Architecture

The detector architecture has changed since the original concept. Originally, C_ℓ OVER had four identical telescopes at each frequency. The detector chips would contain eight TESs, each of which would be fed by four finlines. Each of these four finlines would receive the same mode from one of the four telescopes, improving the sensitivity of each detector. This meant that the number of detectors would be a quarter of the number of modes from the polarimeters. This scheme was dropped in favour of having a single detector per mode, not least because of the difficulty of plumbing such a complicated waveguide configuration. The current configuration has a single TES on each chip, fed by a single finline. There are two main reasons for going against the current trend towards large monolithic arrays. First, because the focal plane is populated by feedhorns, the waveguides coming

from the polarimeter are on a pitch which is much larger than the size of the detectors. The horn diameters are 20, 8.4, and 12.77 mm at 97, 150, and 220 GHz, respectively. A monolithic array would have large inactive areas between active elements, increasing the number of wafers that would have to be processed, and hence the cost and manufacturing time. Second, because high sensitivity is essential for achieving $C\ell$ OVER’s science goals, we decided to fabricate each detector on a single chip so that good devices could be selected to guarantee that all the detectors in each focal plane are working. The chips are micromachined and diced by deep reactive ion etching (DRIE) at the Scottish Microelectronics Centre.

Another change to the instrument is that $C\ell$ OVER will now be sited in the Atacama Desert in Chile, instead of Dome C in Antarctica, as was originally planned. This affects the detector power-handling and sensitivity requirements (see Sect. 2.1). The main features of the $C\ell$ OVER detectors and how they have changed are summarized in Table 2.

Table 2. Current $C\ell$ OVER detector architecture compared with original concept.

Feature	Original	Current
detectors per chip	8	1
microstrips per detector	4	1
Multiplexing	Frequency-domain	Time-domain
Multiplexing level	8	16 (97 GHz) 20 (150, 220 GHz)

2.3. R.F. Design

To reach background-limited sensitivity $C\ell$ OVER’s bolometers must have a high absorption efficiency. Power is coupled from the waveguide to the TES planar circuit using an antipodal finline taper consisting of two superconducting fins of Nb separated by 400 nm of SiO_2 ^{5,6} (see Fig. 1). The lower Nb layer is 250 nm thick. The upper layer is 500 nm thick to ensure reliable lift-off patterning with the step over the oxide layer. The whole structure is deposited on one side of a 225- μm silicon substrate. Before the fins overlap, the thickness of the SiO is much less than that of the silicon and the structure behaves as a unilateral finline. As the fins overlap, the structure starts to behave like a parallel-plate waveguide with an effective width equal to the overlap region. When the width of the overlap region becomes large enough for fringing effects to be negligible, a transition to a microstrip mode has been performed. The microstrip is then tapered to the required width. $C\ell$ OVER uses a 3- μm Nb microstrip with a characteristic impedance of 20 Ω to deliver power to the TES.

The detector chip’s 225- μm silicon substrate loads the waveguide in which it sits, changing the waveguide impedance. To prevent reflections the chip has a tapered end which provides a gradual impedance transition. The prototype detectors for the Single Pixel Demonstrator sit in a WR-10 waveguide and have a taper angle of 40°. This angle was chosen based on finite-element electromagnetic modelling.

2.4. Bolometer Design

$C\ell$ OVER’s bolometers are low-stress silicon nitride islands suspended on four legs (see Fig. 2). The nitride is 0.5 μm thick. The thermal conductance to the thermal bath is controlled by the four nitride legs. The microstrip carrying power from the finline to the bolometer is terminated by a 20- Ω Au/Cu resistor which dissipates the incoming power as heat that the superconducting transition edge sensor (TES) can detect. A shunt resistor in parallel with the TES ensures that it is voltage biased so that it operates in the regime of strong negative electrothermal feedback.⁷ For example, if the temperature drops, so does the resistance of the TES. Since it is biased at constant voltage, this means that the current, and hence the Joule power, will increase, heating up the TES. Conversely, if the temperature increases the resistance will increase, reducing the current, and thus the Joule heating. This means that the TES operates at a bias point that is in a stable equilibrium. Thus, the TES is self-biasing. There is no need for a temperature controller to ensure that it remains at the correct bias point.

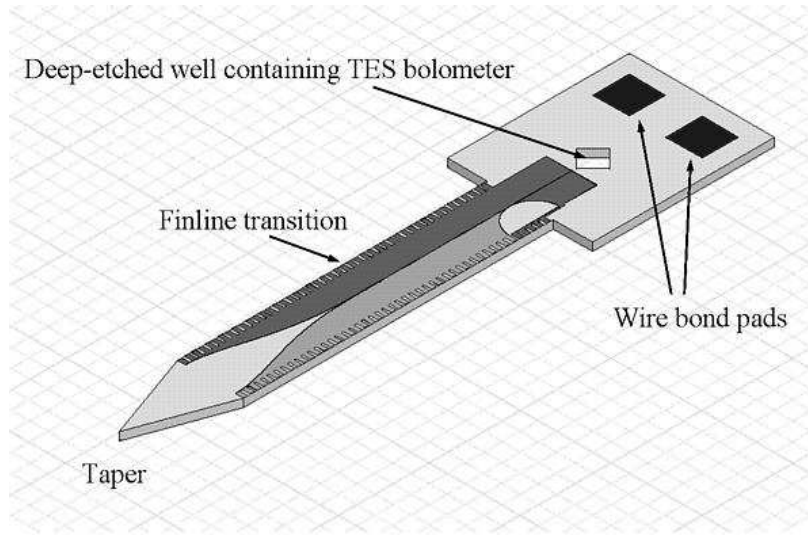


Figure 1. Layout of prototype $C_\ell\text{OVER}$ detector chip.

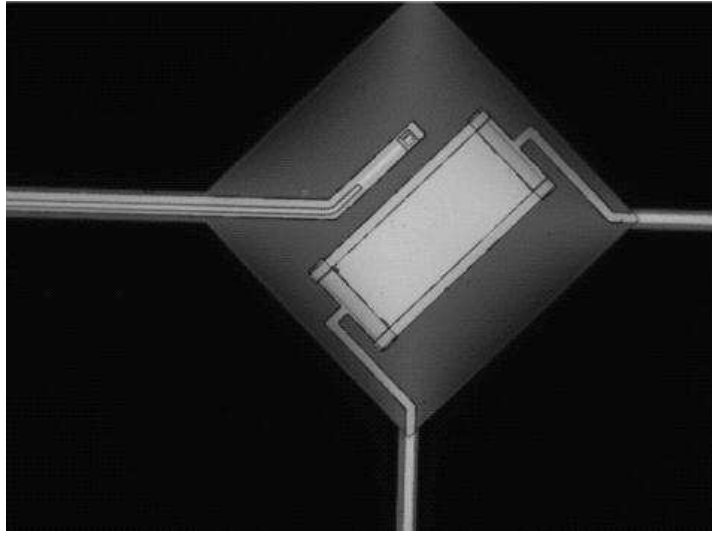


Figure 2. $C_\ell\text{OVER}$ prototype bolometer silicon nitride island showing TES and microstrip leading to termination resistor.

Also, the electrothermal feedback cancels out temperature fluctuations which has the effect of suppressing the Johnson noise.

The TES films in $C_\ell\text{OVER}$ are Mo/Cu proximity-effect bilayers. The transitions of the bilayers can be made as sharp as 1–2 mK for high sensitivity. The sensitivity of the TES shown in Fig. 3 is $\alpha = \frac{T}{R} \frac{dR}{dT} = \frac{d \log R}{d \log T} \approx 300$. We can also tune the transition temperature (T_c) of the films to the desired value by choosing the film thicknesses.

The operating temperature of $C_\ell\text{OVER}$'s detectors is chosen to meet the NEP requirements and is dominated by the phonon noise. Cooling is provided by a Cryomech PT-405 pulse-tube cooler, a high-capacity Simon Chase He-7 cooler, and a miniature dilution refrigerator.⁸ Because a TES is a low-impedance device it is not very susceptible to microphonics, making it feasible to use a pulse-tube cooler. The 97 and 150-GHz detectors will operate with a base temperature of 100 mK and $T_c = 190$ mK, while the 220-GHz detectors require a base

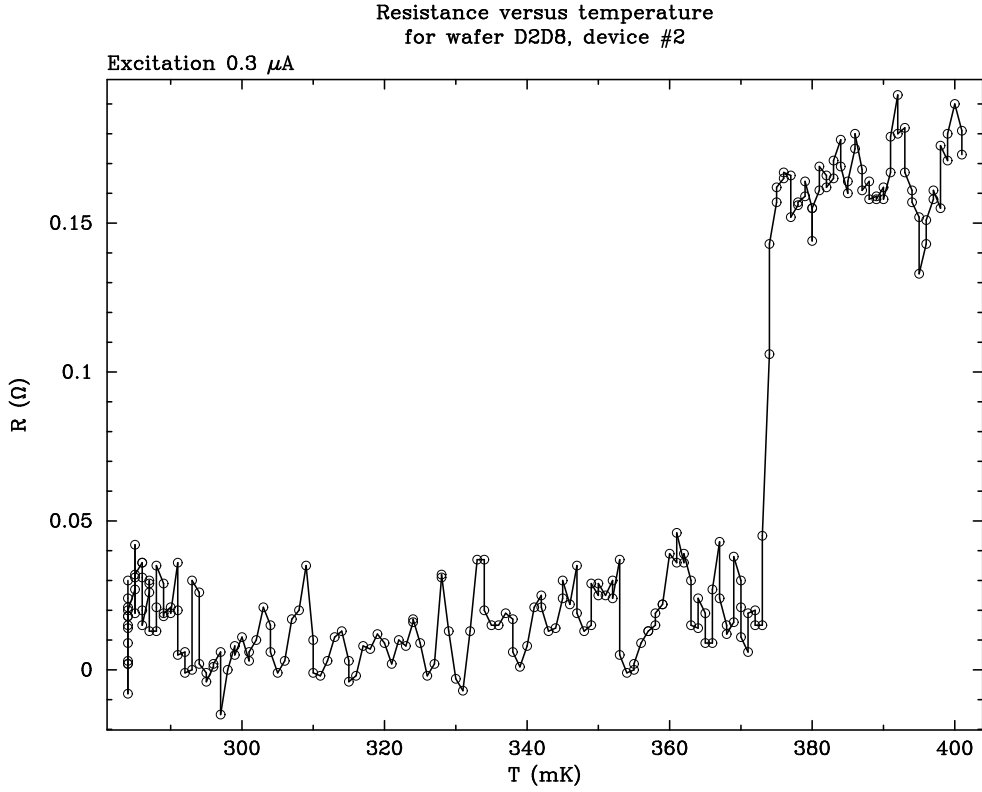


Figure 3. Resistance versus temperature plot for one of the prototype $C_\ell\text{OVER}$ detectors. The transition is 1–2 mK wide and $T_c = 373.5$ mK.

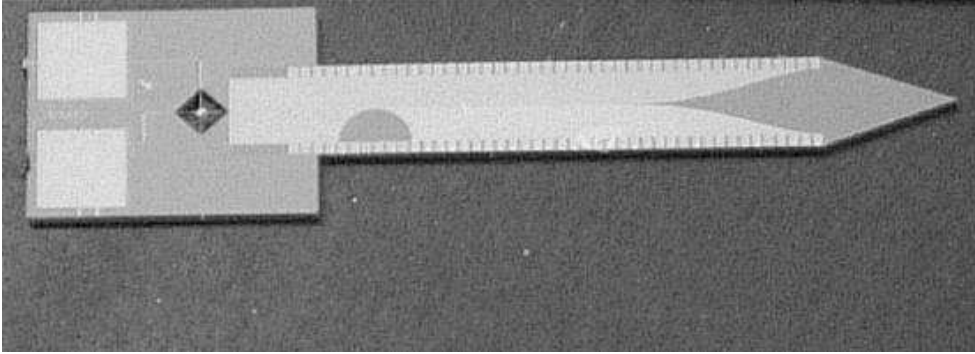


Figure 4. Prototype $C_\ell\text{OVER}$ detector chip. The chip is about 16 mm long.

temperature of 230 mK and $T_c = 430$ mK.

All of the detectors for the Single Pixel Demonstrator have been fabricated and are undergoing testing. Figure 4 shows a prototype $C_\ell\text{OVER}$ detector chip. We plan to carry out RF measurements of the $C_\ell\text{OVER}$ detectors in the near future using a cryogenic black body source.

3. READOUT

Given the large number of detectors in this instrument (320 at 97 GHz and 512 each at 150 and 220 GHz) some form of multiplexing is needed to have a manageable number of wires from room temperature. We use 1×32

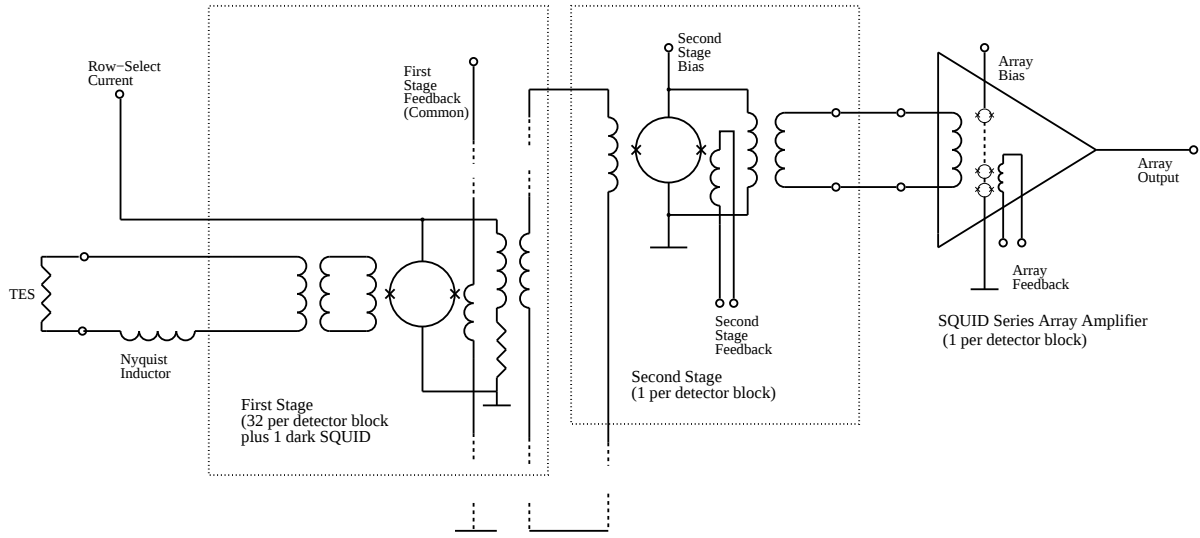


Figure 5. Simplified diagram of the $C\ell$ OVER readout. The dummy SQUID that cancels out crosstalk is not shown. Note that all grounding is done outside the cryostat. For every line that enters the instrument there is a return line.

SQUID multiplexers^{9,10} fabricated by the National Institute of Standards and Technology. A simplified view of the $C\ell$ OVER readout is shown in Fig. 5. The first and second stage SQUID amplification stages are contained in a 1×32 multiplexer chip. The first stage is actually a balanced pair of SQUIDs. One of the SQUIDs in a pair is unbiased and cancels out crosstalk in unaddressed pixels as the SQUID bias and feedback are switched from row to row. There is also a 33rd dark SQUID on each chip which is used to cancel out drift ($1/f$ noise) in the downstream electronics. All the multiplexer chips in each of $C\ell$ OVER’s three telescopes share address lines, significantly reducing the number of wires needed to room temperature. The Nyquist inductors, which slow down the circuit to make it stable against oscillations, are contained in a separate chip. Both of these chips and the shunt resistors are mounted on a PCB at 100 mK and connections are made to the detectors by aluminium wire bonds. The SQUID series arrays¹¹ that provide the third stage of amplification are mounted in eight-chip modules which provide the necessary magnetic shielding. These modules are heat-sunk to the 4-K stage of the cryostat and they are connected to the multiplexer PCB with superconducting NbTi twisted pairs. Room-temperature multi-channel electronics (MCE), developed by the University of British Columbia, provide SQUID control and readout as well as TES bias. $C\ell$ OVER’s MCE is similar to that used by SCUBA-2.¹²

4. DETECTOR PACKAGING

4.1. Populating the Focal Plane

The feedhorns are arranged in a hexagonal array. However, the 1×32 multiplexer chips we are using lend themselves more naturally to a planar configuration where we have up to 16 horns in a row. We therefore had to come up with a compromise arrangement which would allow us to tile the focal plane efficiently. As shown in Fig. 6 we split the 97-GHz focal plane into three regions. Clockwise from upper right these are a 7×7 -horn parallelogram, an 8×7 -horn parallelogram, and an 8×8 -horn parallelogram. The two waveguides corresponding to each horn are arranged so that they are all parallel within one of these regions. This allows us to cover each region with linear detector blocks stacked on top of each other with an offset to match the hexagonal horn pitch. The orientation of one of these detector blocks is shown by a dark rectangle in each of the three regions. The main advantage of this arrangement is that it allows us to use identical detector blocks to cover a focal plane, reducing cost and complexity. The 97-GHz focal plane needs 22 detector blocks to cover it. The scheme for covering the 150- and 220-GHz focal planes is similar, except that the horns are arranged in a hexagon with a

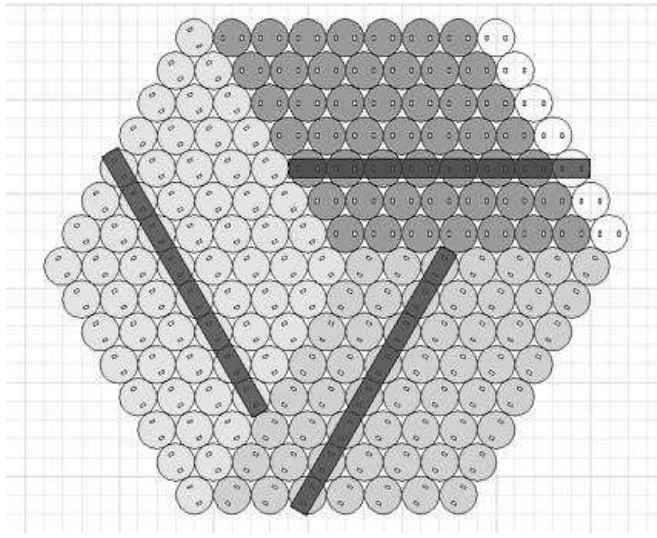


Figure 6. Layout of 90-GHz focal plane. The dark rectangles show the orientation of linear detector blocks.

side of ten horns. This means that there are 28 detector blocks, each containing 20 detectors and one 1×32 multiplexer chip.

This scheme has the apparent disadvantage that we are under-using the 1×32 multiplexer chips by a factor of up to two, increasing the number needed. However, because we are not using all of the first-stage SQUIDs on a multiplexer chip, we can connect the detectors to those SQUIDs that have the most similar critical currents. This optimizes the first-stage SQUID biasing, reducing the noise contribution from this stage of the readout. Reducing the number of detectors multiplexed by each multiplexer chip also reduces the aliased readout noise, improving the NEP. Another advantage of under-using the multiplexer chips is that we can use chips where not all the first-stage SQUIDs are functioning, reducing the cost per chip.

4.2. Detector Block

The detector block comes in two halves, upper and lower. When these are put together they form split-block waveguides, into which the finlines protrude. The edges of the finlines stick into shallow slots in the sides of the waveguides for grounding. The serrations on the edges of the finlines (see Fig. 1) are there to prevent unwanted modes from propagating. A simplified view of a detector block holding four detectors is shown in Fig. 7.

Aluminium wire bonds provide electrical connections from the detector chip to a PCB carrying the multiplexer, inductors, and shunt resistors. This PCB has gold-plated copper tracks and as much of the copper as possible is left on the board to help with heatsinking. The gold is deposited by electroplating in order to avoid the use of a nickel undercoat. The traces are tinned with solder to make them superconducting. The PCB is enclosed in a copper can which is wrapped in niobium foil under which there is a layer of Metglas[®] 2705M, a high-permeability amorphous metal foil (Hitachi Metals Inc.). The Nb foil excludes magnetic fields while the Metglas diverts any trapped flux away from the SQUIDs. Further magnetic shielding is provided by high-permeability shields built into the cryostat.

4.3. Detector Mounting Scheme

In the final instrument each detector block will carry either 16 or 20 detectors. We would like to be able to remove and replace one of these detectors without disturbing the others. Thus, we mount each detector chip on an individual copper chip holder, which is then mounted in the detector block.

We must make good thermal contact to the back of each detector chip, while at the same time relieving stresses caused by differential contraction that could demount or break the chip. We fix the chip to a chip

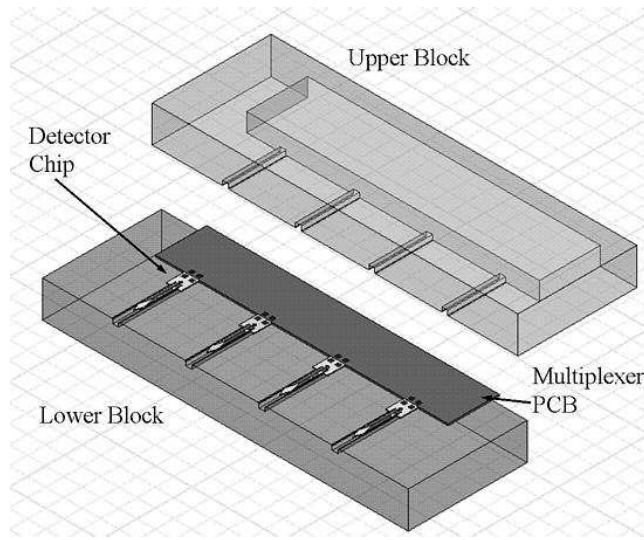


Figure 7. Detector block concept showing how four detectors would be mounted in a block. The upper and lower blocks form waveguides in which the finlines sit.

holder using epoxy. We carried out thermal cycling tests with various different epoxies and the best results were obtained with Stycast 1266. The chip holder has a well in the centre to divert excess epoxy away from the suspended nitride island.

The chip holder is secured to the detector block by two brass screws. A piece of Nb foil between the chip holder and the detector block provides magnetic shielding for the detector chip.

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REFERENCES

1. M. J. Rees, “Polarization and Spectrum of the Primeval Radiation in an Anisotropic Universe,” *ApJ* **153**, pp. L1+, July 1968.
2. U. Seljak and M. Zaldarriaga, “Signature of Gravity Waves in the Polarization of the Microwave Background,” *Physical Review Letters* **78**, pp. 2054–2057, Mar. 1997.
3. M. Kamionkowski, A. Kosowsky, and A. Stebbins, “A Probe of Primordial Gravity Waves and Vorticity,” *Physical Review Letters* **78**, pp. 2058–2061, Mar. 1997.
4. P. G. Calisse, P. A. R. Ade, M. D. Audley, P. Cabella, A. D. Challinor, P. Ferreira, W. K. Gear, D. J. Goldie, P. K. Grimes, K. Isaac, M. E. Jones, B. Kiernan, M. Crane, R. W. Barker, K. Grainge, P. F. Horner, B. J. Johnson, A. N. Lasenby, B. Maffei, P. D. Mauskopf, S. J. Melhuish, C. E. North, A. Orlando, S. M. Parsley, L. Piccirillo, L. Pietranera, O. E. Mallie, G. Pisano, G. Savini, H. M. Stevenson, A. C. Taylor, G. Teleberg, I. Thomas, V. N. Tsaneva, C. E. Tucker, R. Tucker, I. Walker, S. Wilcox, S. Withington, G. Yassin, L. Dunlop, D. Glowacka, D. T. O’Dea, G. Rocha, and A. C. Readhead, “Clover: a high-sensitivity polarization instrument for CMB B-mode observations.” SPIE 6275, in press, 2006.
5. G. Yassin and S. Withington, “Electromagnetic models for superconducting millimetre-wave and sub-millimetre-wave microstrip transmission lines,” *Journal of Physics D Applied Physics* **28**, pp. 1983–1991, Sept. 1995.

6. G. Yassin, S. Withington, M. Buffey, K. Jacobs, and S. Wulff, "A 350-GHz SIS antipodal finline mixer," *IEEE Trans. on Microwave Theory and Techniques* **48**(4), pp. 662–669, 2000.
7. K. D. Irwin, *Phonon-Mediated Particle Detection Using Superconducting Tungsten Transition-Edge Sensors*. PhD thesis, Stanford University, Stanford, California, 1995.
8. G. Teleberg and L. Piccirillo, "A miniature dilution refrigerator for sub-Kelvin detector arrays." SPIE 6275, in press, 2006.
9. J. A. Chervenak, K. D. Irwin, E. N. Grossman, J. M. Martinis, C. D. Reintsema, and M. E. Huber, "Superconducting multiplexer for arrays of transition edge sensors," *Applied Physics Letters* **74**, pp. 4043–4045, June 1999.
10. P. A. J. de Korte, J. Beyer, S. Deiker, G. C. Hilton, K. D. Irwin, M. Macintosh, S. W. Nam, C. D. Reintsema, L. R. Vale, and M. E. Huber, "Time-division superconducting quantum interference device multiplexer for transition-edge sensors," *Review of Scientific Instruments* **74**, pp. 3807–3815, Aug. 2003.
11. R. P. Welty and J. M. Martinis, "Two-stage integrated SQUID amplifier with series array output," *IEEE Transactions on Applied Superconductivity* **3**, pp. 2605–2608, Mar. 1993.
12. M. D. Audley, W. S. Holland, T. Hodson, M. MacIntosh, I. Robson, K. D. Irwin, G. Hilton, W. D. Duncan, C. Reintsema, A. J. Walton, W. Parkes, P. A. R. Ade, I. Walker, M. Fich, J. Kycia, M. Halpern, D. A. Naylor, G. Mitchell, and P. Bastien, "An update on the SCUBA-2 project," in *Millimeter and Submillimeter Detectors for Astronomy II. Proceedings of the SPIE, Volume 5498*, J. Zmuidzinas, W. S. Holland, and S. Withington, eds., pp. 63–77, Oct. 2004.